Autolad3G

(UL ANSI: FR-15.1) Halogen Free, High performance, Automotive-use laminate

FEATURES

- Lead-free compatible
- Very low Z-axis CTE: 1.8% (50~260°C)
- Excellent performance in anti-CAF performance and temperature cycling test
- High thermal resistance

GENERAL PROPERTIES

APPLICATIONS

Specified for Automotive Electronics, including junction box, ECU in engine and body

GENERAL PROPERTIES						
Test Items	Test Method	Test Condition	Unit	Typical Value		
Tg	IPC-TM-650 2.4.25D	DSC °C		190		
	IPC-TM-650 2.4.24.3	ТМА	°C	180		
	IPC-TM-650 2.4.24.2	DMA	°C	200		
Td	IPC-TM-650 2.4.24.6 Wt 5% loss		°C	408		
T300	IPC-TM-650 2.4.24.1	ТМА	min	> 60		
T288	IPC-TM-650 2.4.24.1	ТМА	min	> 60		
Thermal Stress	IPC-TM-650 2.4.13.1	288°C,20s (Unetched/Etched)	-	Pass/Pass		
CTE(Z-axis)	IPC-TM-650 2.4.24	Before Tg	ppm/°C	35		
	IPC-TM-650 2.4.24	After Tg	ppm/°C	180		
	IPC-TM-650 2.4.24	50-260°C	%	1.8		
Dielectric Constant(10GHz)	IPC-TM-650 2.5.5.5	C-24/23/50	-	4.0		
Dissipation Factor(10GHz)	IPC-TM-650 2.5.5.5	C-24/23/50	-	0.013		
Volume Resistivity	IPC-TM-650 2.5.17.1	After moisture resistance	MΩ-cm	4.0×10 ⁹		
	IPC-TM-650 2.5.17.1	E-24/125	IVI22-CITI	5.0×10 ⁶		
Surface Registivity	IPC-TM-650 2.5.17.1	After moisture resistance	MΩ	8.0×10 ⁸		
Surface Resistivity	IPC-TM-650 2.5.17.1	E-24/125	IVIS2	2.0×10 ⁸		
Arc Resistance	IPC-TM-650 2.5.1	D-48/50+D-0.5/23	S	160		
Dielectric Breakdown	IPC-TM-650 2.5.6	D-48/50+D-0.5/23	kV	45+KV NB		
Peel Strength (1 Oz)	IPC-TM-650 2.4.8	288°C, 10s/125°C	N/mm	1.3/1.25		
Flexural Strength(LW/CW) IPC-TM-650 2.4.4		A	Мра	560/450		
Water Absorption	IPC-TM-650 2.6.2.1	D-24/23	%	0.13		
Flammability	UL94	C-48/23/50, E-24/125+des	Rating	V-0		

Remark:

1. All the typical value is based on the 1.6mm (8*7628) specimen. The Dk and Df value is based on 57% RC.

2. All the typical value listed above is for your reference only, please turn to Shengyi Technology Co., Ltd for detailed information, and all rights from this data sheet are reserved by Shengyi Technology Co., Ltd.

Explanations: C=Humidity conditioning; D=Immersion conditioning in distilled water; E=Temperature conditioning.

The figures following the letter symbols indicate with the first digit the duration of the preconditioning in hours, with the second digit the preconditioning temperature in $^{\circ}$ C and with the third digit the relative humidity.



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(UL ANSI: FR-15.1) Bonding Prepreg for Autolad3G

PREPREG PARAMETERS

Glass fabric type	Resin content (%)	Cured thickness (mm)
106	74	0.051
1067	67	0.051
	71	0.058
1080/1078	65	0.076
1000/1070	69	0.086
3313	53	0.089
3313	58	0.102
	52	0.109
	53	0.114
2116	57	0.127
	58	0.130
	61	0.142
1500	46	0.150
1506	48	0.160
7628	47	0.203
1020	50	0.213

Other type, resin content and size could be available upon request.

HOT PRESSING CYCLE

- The heat-up rate depends on the inner copper or the structure of multilayer PCB.
- Curing time: >90min (195~205°C).
- If you need any more detail information, please turn to Shengyi Technology Co., Ltd.

STORAGE CONDITION

- 3 months when stored at < 23° C and <50% RH.
- 6 months when stored at <5 °C. Normalize in room temperature for at least 4h before using.
- Beware of moisture, always keep wrapped in damp-proof material. Keeping in normal condition, prepreg might absorb moisture and its bonding strength would be weakened.
- Avoid UV-rays and strong light.

PURCHASING INFORMATION

Thickness	Copper foil	Standard size		
0.05mm	12um	1,020mm×1,220mm (40"×48")	915mm×1,220mm (36"×48")	
to 3.2mm	to 210 um	1,070mm×1,220mm (42"×48")		

Remarks: Other sheet size and thickness could be available upon request.